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NEXCHIP SEMICONDUCTOR CORPORATION

合肥晶合集成電路股份有限公司

(A joint stock company incorporated in the People's Republic of China with limited liability)

(Stock Code: 2249)

DATE OF BOARD MEETING

The board (the “**Board**”) of directors of Nexchip Semiconductor Corporation (the “**Company**”) hereby announces that a meeting of the Board will be held on Monday, August 24, 2026, for the purpose of considering and approving the interim results of the Company and its subsidiaries for the six months ended June 30, 2026 and its publication, considering the recommendation on payment of an interim dividend, if any, and transacting any other business.

By order of the Board

Nexchip Semiconductor Corporation

合肥晶合集成電路股份有限公司

Mr. Tsai Kuo-Chih

Executive Director and chairperson of the Board

Hong Kong, August 12, 2026

As at the date of this announcement, the Board comprises: (i) Mr. Tsai Kuo-Chih and Mr. Zhu Caiwei as Executive Directors; (ii) Mr. Lu Qinhang, Ms. Chen Xiaobei, Mr. Guo Zhaozhi and Mr. Qiu Wensheng as Non-executive Directors; and (iii) Prof. An Guangshi, Prof. Lin Zhiting and Mr. Chen Ting as Independent non-executive Directors.